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(54) Chemical vapor delivery system and method for controlling the flow of vapor in a chemical vapor delivery system.

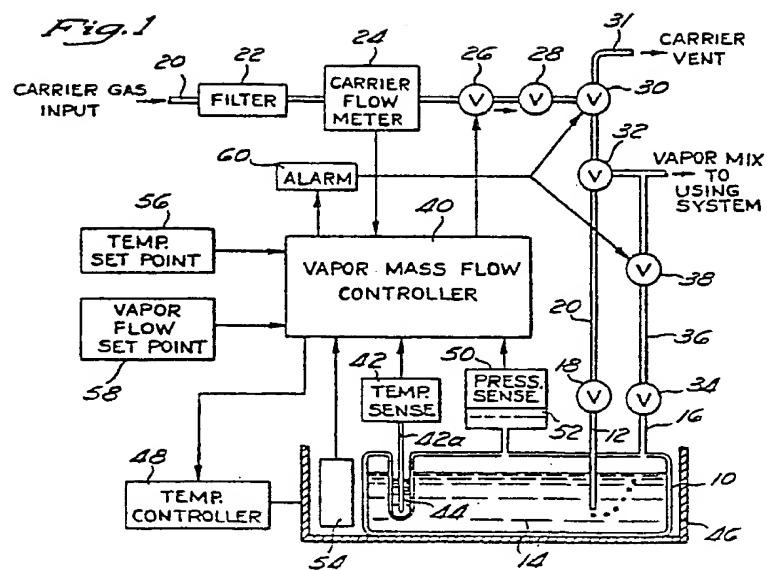
(57) The previous methods of controlling the flow of vapor transported by a carrier gas from a bubbler (10) to a using system have customarily been the thermal-conductivity mass flow meter and the temperature controlled vaporizer bubbler (10). However, such control methods have the disadvantage that fluctuations occur in the vapor mass flow.

In accordance with the present invention the flow of vapor transported by a carrier gas from a bubbler (10) to a using system is controlled to provide an uninterrupted uniform mass flow of the vapor to the using system. Control of the flow of vapor is achieved by controlling the temperature (48) and pressure (50) within the bubbler (10).

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Fig. 1



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DESCRIPTION

"CHEMICAL VAPOR DELIVERY SYSTEM AND METHOD FOR
CONTROLLING THE FLOW OF VAPOR IN A CHEMICAL
VAPOR DELIVERY SYSTEM"

5 This invention relates to an improved system for controlling the flow of vapor transported by a carrier gas from a bubbler to a using system. The control system is particularly useful in connection with high purity liquid source material used in the manufacturing 10 of semiconductor devices.

The fabrication of semiconductor electronic devices includes many steps which require the transport of particular atoms or molecules to the surfaces of wafer substrates, usually maintained at elevated temperatures.

15 In many of the steps, the most common method for accomplishing this is to transport the vapors from a liquid chemical source by a carrier gas stream into a reaction chamber of the using system. Consistent device performance depends strongly on accurate vapor 20 delivery rates and extremely low levels of impurities, particularly metallics.

Typically, an ultra-high purity liquid source material is provided in a bubbler, and a suitable carrier gas stream is bubbled through the liquid and 25 then transported to the point of use. The previous methods of vapor flow control that have been customarily used are the thermal-conductivity mass flow meter and the temperature controlled vaporizer bubbler; however, neither method has been entirely satisfactory.

30 The thermal conductivity mass flow meter monitors the vapor flow from a liquid source bubbler by taking the ratio of the thermal-conductivity of the carrier gas and vapor mixture flowing out of the bubbler, to the thermal-conductivity of the carrier gas 35 flowing into the bubbler (see for example U.S. Patent 3,650,151). The main drawback of this method is the

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introduction of metallic contamination in the vapor stream. The design and construction of the thermal mass flow meter has necessitated the use of metallic parts, usually stainless steel, in the chemical vapor path. Because of the highly corrosive nature of many of the commonly used chemical vapors (especially in the presence of trace levels of moisture contamination) the metallic parts slowly deteriorate and the resulting metallic impurities are carried with the source vapor to the wafers. This leads not only to wafer contamination and low device yields, but also to drift and failure in the mass flow controller caused by the chemical deterioration. In addition the cost of the meters themselves is not a small problem in that they are costly, in the area of \$2,000, and must be frequently repaired and replaced. This is particularly so with high carrier gas flow, such as in fiber optic applications.

The temperature controlled bubbler method maintains constant vapor mass flow by closely controlling the bubbler temperature and the mass flow rate of the carrier gas stream. Recently introduced improved bubblers, such as those illustrated in U.S. Patents 4,134,514 and 4,140,735 eliminate many contamination and deterioration problems by using only high-purity quartz and teflon in contact with the vapors, and by eliminating chemical handling problems. The main drawback to this method has been fluctuations in the vapor mass flow such that the output has not always been sufficiently satisfactory and has required considerable trial and error adjusting of the carrier gas stream. As a result of inadequate controls, there is a significant and frequent loss of partially finished goods. In addition, there have been some reported instances of connections being broken or

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bubbler exploding because of improperly high pressures of the carrier gas streams. This results in danger to operating personnel because of the corrosive nature of the liquid source material, as well as the possible 5 loss of the expensive work in progress, such as a batch of semiconductor wafers. Accordingly, a need exists for improved flow control of such a bubbler system. The present invention relates to such an improvement for the temperature controlled type bubbler 10 system.

In the operation of temperature controlled bubbler systems, it had been assumed that maintaining a reasonably accurate control of the temperature of the liquid source material and monitoring the flow of the 15 carrier gas would provide sufficient consistency of the vapor flow, since the saturation point of the carrier gas varies with temperature. However, close analysis has revealed a number of sources of error.

For example, it had been assumed that there was no need to monitor pressure in that the using system 20 was at atmospheric pressure and that therefore the vapor pressure within the bubbler was essentially at atmospheric. It has been learned that simple changes in atmospheric pressure can produce an undesirable error in the vapor mass flow. Further, the existence 25 of valves downstream from the bubbler can introduce back pressure variations such that the bubbler vapor pressure is above atmospheric pressure. Related to this, simply the length of the fluid line from the bubbler to the using system introduces variations in 30 back pressure.

Also, it has been discovered that variation in the size of the opening through which the gas passes in exiting the bubbler can introduce pressure variations

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that result in a source of error. Typically, a thin glass seal in the bubbler inlet had been broken by magnetically raising a small metal ball and dropping it to break the seal. Variations in the size of the 5 opening can affect the accuracy of the system, and use of the present invention accomodates such variations.

It has further been found that certain errors are introduced into the system by temperature variations that are not sufficiently accomodated by the means 10 employed for maintaining the liquid source material at constant temperature. For example, sudden ambient temperature changes, such as that caused by opening a nearby oven door, can introduce temporary errors that cannot be quickly corrected by a temperature controller. 15 Further, in some uses of the system such as the fabrication of fiber optics, a relatively large flow of carrier gas is required. It has been found that this increased carrier gas flow rate can introduce significant evaporative cooling such that ten to 20 fifteen minutes may be required to stabilize the temperature. This of course results in the loss of very expensive bubbler vapor as well as delaying the manufacturing process.

Related to the high carrier gas flow rate situation, 25 it was commonly thought that an increased flow rate would result in the carrier gas not being saturated as it bubbled through the liquid source material; however, while this is true with extremely high flow rates, analysis has shown that the rates in question do not 30 result in inadequate saturation, but that instead variations are caused by some of the other sources of error referred to above.

The operation of the vapor mass flow controller of the present invention is based on the theory that 35 accurate vapor mass flow from a liquid source bubbler

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can be obtained, if the temperature and pressure of the bubbler and the carrier gas mass flow are known. In addition to these factors, an empirically observed correction factor, depending on bubbler geometry,

5 temperature, liquid level, and flow rate must be applied. It should be noted that the change in correction factor due to bubbler geometry is small enough that negligible change is for normal bubbler manufacturing tolerances, such that the correction
 10 factor normally only needs be determined for a particular design. This is important in that it makes the system more useful. The concept is mathematically expressed as follows:

$$15 \quad m = \frac{\alpha F_c}{P - P} \cdot f_c(F_c, T, L)$$

where

m = Vapor mass flow
 F_c = Carrier gas mass flow
 P = Total bubbler pressure
 20 $f_c(F_c, T, L)$ = Empirical correction factor
 T = Bubbler temperature
 L = Liquid level in bubbler
 P = $\delta e^{(\beta - \gamma / T)}$ = partial pressure of the chemical vapor; and

25 α, β, γ , and δ = constants for each chemical

By using this formula and properly measuring the relevant parameters, temperature, pressure, level and carrier gas flow, an accurate determination of the vapor
 30 mass flow can be obtained. One or more of these parameters may be regulated through a feed back loop to control the vapor mass flow to any desired value within the available range of the parameters.

35 In a preferred example of the invention, changes in the variables are combined by an electronic flow

controller which provides an output signal for adjusting the valve controlling the carrier gas flow, which provides the fastest adjustment speed. In addition, a signal is provided to a temperature controller for 5 maintaining the bubbler temperature at a desired point. It has been found that with such a system, the accuracy of the vapor mass flow may be controlled to within one percent variation.

As additional features of the invention, the flow 10 controller provides an alarm signal, if the level of liquid in the bubbler drops below a certain minimum required to obtain adequate saturation of the carrier gas. Additionally, the alarm indicates an overpressure condition and closes the input valve to interrupt the 15 flow of carrier gas, if an overpressure condition should occur within the bubbler. A safety relief valve is also provided to relieve the pressure within the bubbler at a predetermined level.

The present invention will now be further described 20 with reference to the accompanying drawings, in which:-

Figure 1 is a block diagram indicating the overall arrangement and operation of the system; and

Figure 2 is a block diagram indicating a mass flow approximation circuit of the electronic controller.

25 Referring to Figure 1, there is schematically illustrated a vaporizer bubbler 10 having an inlet tube 12 which enters through the upper wall of the bubbler and terminates at an open end near the bottom of the bubbler so that carrier gas exiting from the inlet tube 30 will bubble upwardly through a quantity of liquid 14 within the bubbler container. The bubbler further has an outlet tube 16 in the upper wall of the bubbler in communication with the vapor space above the liquid in the bubbler. The bubbler is preferably made of high 35 purity quartz material which will not react with the

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liquid or the carrier gas. Further details of two suitable bubblers may be obtained from U.S. Patents 4,134,514 and 4,140,735.

5 The bubbler inlet tube is connected by a manually operated valve 18 to a carrier gas inlet line 20. The upper end of the inlet line is connected to a suitable carrier gas input source. Moving downstream from the carrier gas input, there is positioned a filter 22, a carrier gas flow meter 24, a carrier gas flow control 10 valve 26, a check valve 28, a three-way vent valve 30, and a pressure relief valve 32.

15 The bubbler outlet tube 16 is connected by manually operated valve 34 to an outlet line 36 past a shut-off valve 38 for connection to a using system (not shown). A typical using system is a batch of semiconductor wafers in a furnace in which the bubbler liquid vapor is to be deposited at an elevated temperature.

20 A vapor mass flow controller 40 receives a variety of input information and provides an output signal for controlling the flow control valve 26. One input is the temperature of the bubbler liquid 14 as measured by a temperature sensor 42 which includes a probe 42a extending into a thin-walled well 44 formed in the 25 bubbler. The probe makes good thermal contact with the well by means of a heat transfer fluid positioned within the well.

30 The bubbler is positioned in a container or shell 46 for maintaining the bubbler at a desired temperature. The temperature controller 48 connected to the vapor mass flow controller 40 provides heat or extracts heat, to the container 46 to monitor the bubbler at a desired level. Together, the container 46 and the controller 48 form a unit often referred to as a source-temperature 35 controller (STC).

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A pressure sensor or transducer 50 senses the pressure in the upper portion of the bubbler above the liquid and feeds a pressure input to the flow controller 40. The pressure transducer preferably 5 includes an isolating diaphragm 52 which is exposed on one side to the bubbler interior, with the other side of the diaphragm confining a non-compressible fluid in the upper portion of the pressure sensor. The diaphragm 52 is preferably made of teflon or some 10 other suitable material which can resist the chemicals to be confined within the bubbler, while not introducing any contaminant into the source material.

A suitable sensor 54 senses the level of the liquid in the bubbler and provides a level input signal to 15 the flow controller 40. The sensor provides information for calculating the vapor flow and for determining when the chemical supply is depleted. The level can be determined by knowing the starting level and keeping track in the mass flow controller of the total volume 20 of vapor lost to the carrier gas stream. Another method which can be used is to sense the level by means of light emitting and detecting devices on the inner walls of the container 46.

Suitable means 56 is provided for furnishing 25 temperature set point information to the flow controller 40. Similarly, means 58 provides a vapor flow set point value to the controller. Also, the carrier gas flow meter 24 is connected to provide carrier gas flow information to the controller. As an additional 30 feature of the system, an alarm 60 is provided to receive a signal from the controller if certain undesired conditions should occur such as an overpressure condition in the bubbler or a lack of sufficient liquid in the bubbler. The alarm means 60 is further connected to the 35 inlet and outlet valves 30 and 38.

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In operation, the bubbler is first connected to the system as shown, the manually operated valves 18 and 34 being connected to the bubbler inlet and outlet tubes in a manner to prevent contamination with respect 5 to the bubbler liquid. The details of one suitable manner for making connections to a bubbler are described in U.S. Patent 4,134,514.

The temperature set point means 56 is adjusted to provide the desired temperature information to the 10 controller 40. Similarly the desired vapor flow information is provided to the controller by the component 58. No pressure information need be provided by the user since the controller is preset for a standard of 760 millimeters of mercury. The 15 temperature variation is relatively small with respect to a nominal temperature provided by the temperature set point means, and the pressure variation is also relatively small with respect to atmospheric pressure. Thus, the formula for computing the vapor 20 mass flow, m , can be simplified in the following approximate formula, which is essentially a four-dimensional linear approximation of the formula expressed above:

$$m^* = AF_c (1 + B\Delta T - C\Delta P - DF_c + E\Delta L)$$

25

m^* = Approximate vapor mass flow

F_c = Carrier gas mass flow

ΔT = Temperature variation from nominal = $(T - T_0)$

ΔP = Pressure variation from nominal = $(P - P_0)$

ΔL = Change in liquid level = $-\int m^* dt$

30

A, B, C, D, E = Positive constants computed for each chemical and nominal operating conditions

This approximate formula can be easily implemented in analogue or digital electronics obvious to one

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skilled in that art. However, to further assist in understanding the electronics required by the controller, refer to the block diagram of Figure 2, which shows a mass flow approximation circuit. As can be seen, the 5 variables in the system are amplified and combined to produce a multiplier for combining with the carrier gas mass flow to provide the approximate vapor mass flow. The electronics for such a system can be fabricated relatively inexpensively such that the controller becomes 10 a very practical but yet highly accurate device.

Once the initial information has been fed to the controller and the bubbler is suitably connected to the system, the carrier gas is applied to the input line 20 with the vent valve 30 in open position so that the 15 carrier gas is vented. After a short stabilization period, the valve 38 is opened, and the vent valve 30 moved to permit carrier gas flow into the bubbler. The valves 18 and 34 having been primarily employed to facilitate installation or removal of the bubbler without 20 loss or contamination of chemicals. The system is then in operation; and as variations in the sensed parameters occur, the information is sent to the controller which instantly provides an output signal to the automatic 25 flow control valve 26 to adjust the valve in a manner to maintain a uniform flow of the vaporized source material 14 transported from the bubbler by the carrier gas to the using system.

In a typical example of the system used in connection with the fabrication of semiconductors, the 30 bubbler might contain POCl_3 , at a pressure of 760 mmHg. An inert carrier gas, such as nitrogen is provided at a flow rate of 0 to 500 standard cubic centimeters per minute. A pressure variation, ΔP is likely to be within the range of -50 to +152 mHg, with 35 an approximation error of less than 2 percent in its

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worst case. Because the bubbler temperature is controlled so that its deviation is small, and the pressure deviation is similarly generally small, the nominal operating conditions are well within the 5 approximation range of the approximate linear formula expressed above, and therefore the approximation error is much less than one percent.

If an overpressure condition is detected by the 10 alarm means 60, the input valve 30 closes, and the output valve 38 opens, if it was not already open, to 15 eliminate the overpressure condition. If valve 38 was open, it is locked open to prevent it from being closed while the overpressure condition exists. Additional safety is afforded by the pressure relief 20 valve 32 which vents to the vapor output to prevent bubbler explosion in case of valve failure. The check valve 28 prevents corrosive bubbler liquid from reaching the carrier flow meter.

The foregoing system provides a reliable and 25 practical means for maintaining the accurate vapor mass flow which is necessary in many chemical processes, particularly that used in the fabrication of semiconductor devices.

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CLAIMS

1. A method for controlling the flow of vapor in a chemical vapor delivery system including a container (10) for holding a quantity of material to be vaporized and applied to a system which uses the vapor, means (20, 12, 16, 36) for ducting a carrier gas through said material to transport said vaporized material, a valve (26) for controlling the flow of said carrier gas to said container, and means (42) for controlling the temperature of the material in said container, characterized in that the method comprises:

continually sensing the vapor pressure in said container;

15 comparing said sensed pressure with a reference pressure to provide a pressure differential;

generating a signal utilizing said pressure differential;

20 transmitting said signal to said flow control valve (26) to adjust said flow control valve to control the carrier gas flow to provide an uninterrupted uniform mass flow of said vaporized material to said using system.

2. A method as claimed in claim 1 including the steps of:

25 sensing the temperature of said material to be vaporized;

comparing said sensed temperature with a nominal temperature to determine a temperature differential; and

30 combining said temperature differential with said pressure differential to generate said signal for providing said uniform mass flow of said vaporized material.

3. A method as claimed in claim 2 including:

35 sensing the level of said material in said container;

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determining changes in said sensed levels; combining said changes in said sensed levels with said pressure differential to generate said signal for providing said uniform mass flow of said 5 vaporized material to said using system.

4. A method as claimed in claim 3 wherein the sensed temperature, pressure, flow rate, and material level are utilized to provide uniform vapor mass flow in accordance with the approximate formula:

10 $\dot{m}^* = AF_c (1 + B\Delta T - C\Delta P - DF_c + E\Delta L)$
wherein

\dot{m}^* = Approximate vapor mass flow
 F_c = Carrier gas mass flow
 ΔT = Temperature variation from nominal = $(T - T_0)$
15 ΔP = Pressure variation from nominal = $(P - P_0)$
 ΔL = Change in liquid level = $-\int \dot{m}^* dt$
 $A, B, C,$ = Positive constants computed for each
 D, E chemical and nominal operating conditions.

5. A chemical vapor delivery system comprising
20 a bubbler container (10) for holding a quantity of high purity liquid to be vaporized and applied to a using system; means (20,12,16,36) for transporting a carrier gas through said liquid to transport the vaporized material to the using system; means (24) for sensing the carrier gas flow rate; valve (26) means for controlling the flow of said carrier gas; means for sensing (42) and controlling (48) the temperature of said liquid; and means (50) for sensing the vapor pressure in said container, characterized 25 in that it includes controller means (40) connected to receive the sensed temperature, the sensed pressure and the sensed carrier gas flow rate to produce a signal for controlling said carrier gas flow control
30

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valve means in a manner to produce an uninterrupted uniform mass flow of said vaporized liquid to said using system.

6. An apparatus as claimed in claim 5 including
5 means for sensing the level of liquid in said container, means for providing input from said level sensing means to said controller means which utilizes the changes in level of said liquid in determining the signal to be provided to said flow control valve means.

10 7. An apparatus as claimed in claim 5 including means linked to said controller for interrupting flow of carrier gas into said container at a predetermined pressure.

15 8. An apparatus as claimed in claim 7 further including alarm means linked to said controller for providing an alarm signal if the flow of carrier gas into said bubbler container is interrupted.

20 9. An apparatus as claimed in claim 7 including means for relieving pressure applied to said container at a predetermined pressure by venting said carrier gas to said using system.

Fig. 1

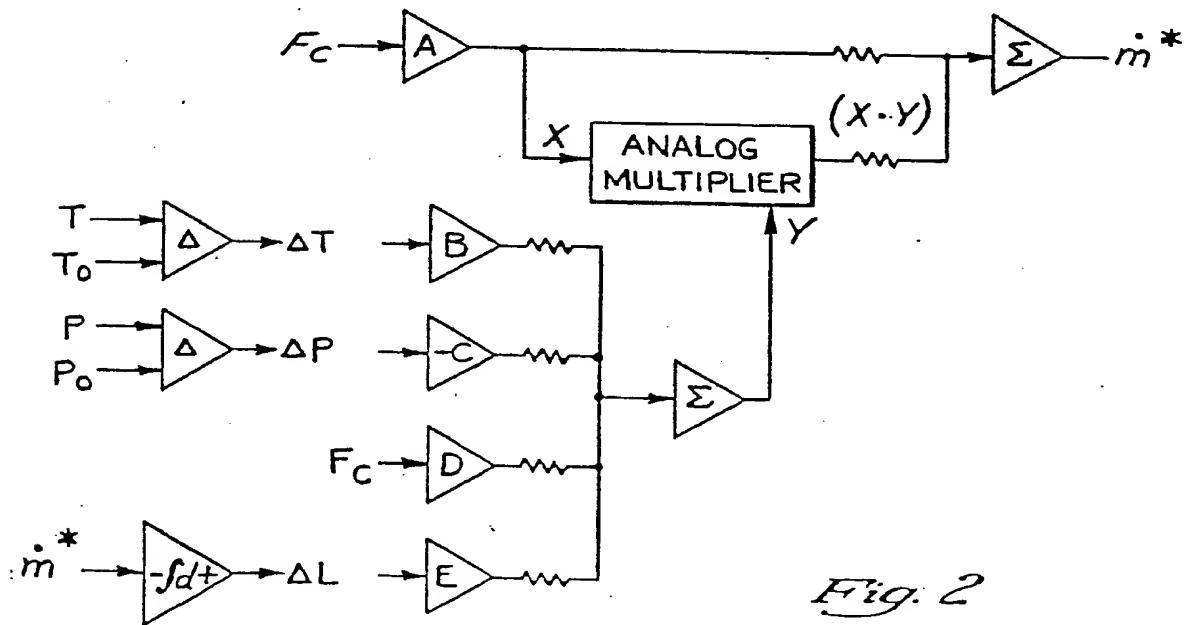
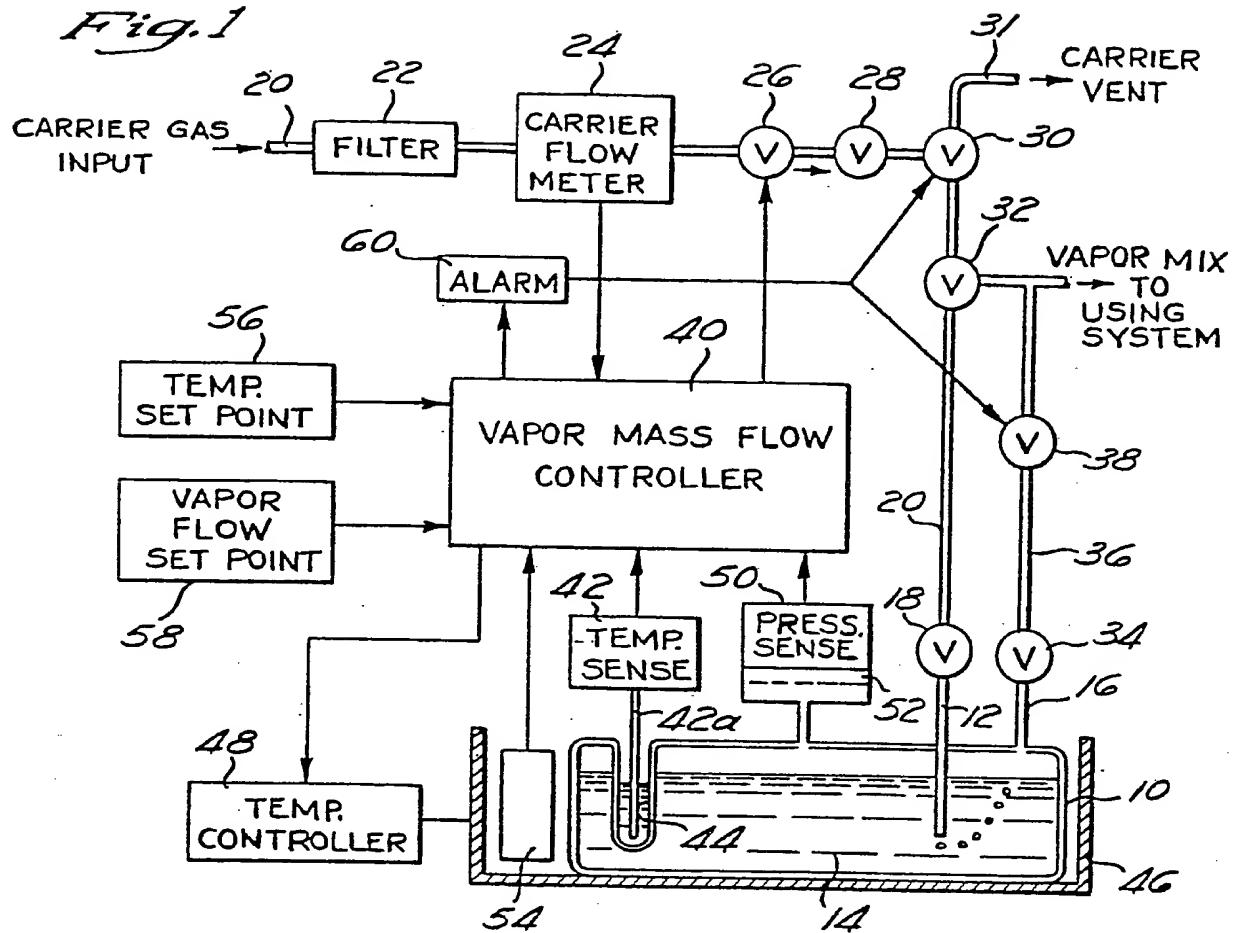


Fig. 2

